



INDSTT/NDIS-23/2023

June 24, 2023

Mr. Randhir Jaiswal
Consul General
Consulate General of India New York
3 East 64th Street,
New York, NY 10065

**Sub: Request for information dissemination of No Dig India Show 2023 – International Conference
& Exhibition on Trenchless Technology
08th & 09th December 2023, Chennai Trade Centre, Chennai, Tamil Nadu, INDIA**

Your Excellency,

Greetings from **Indian Society for Trenchless Technology!**

At the outset, I am taking the liberty to introduce **Indian Society for Trenchless Technology (IndSTT)** the autonomous apex organisation to promote the application of **Trenchless Technology** in India. It was established in 1995 and registered under SR Act of 1860 with registration number 32943 of 1998. Founders of this Society include various luminaries from the Construction Sector.

IndSTT in association with **Construction Industry Development of Council (CIDC – Established by Niti Aayog, Govt. of India)**, is organizing **13th edition of No Dig India Show 2023 - International Conference & Exhibition on application of Trenchless Technology on 08th & 09th December 2023 at Chennai Trade Centre, Chennai, Tamil Nadu, INDIA**. For more details on the event, you may please visit <https://www.nodigindia.com>. For previous editions details, please visit our website at http://www.indstt.com/Event_held.htm.

Trenchless Technology is a construction methodology for creating, maintaining, and managing underground infrastructure like **Water, Sewerage, Power, Oil & Gas and Telecom**, networks without excavating continuous trenches. The technology has immense application in urban construction projects like **Smart City Mission, Atal Mission for Rejuvenation and Urban Transformation (AMRUT), National Mission for Clean Ganga (NMCG), Jal Jeevan Mission, Metros, City Gas Distribution (CGD)** etc.

The objective of the event is to showcase the opportunities, exchange the views and ideas, showcase good practices & help all to chart out the future course of action. We envisage that the presentations by participating countries at the conference will provide a platform for an exchange of relevant experience and interesting information on construction markets, as well as the structure of the construction industry, policies, and projects worldwide.

As an eminent personality in the international arena, I request you to kindly join us as our Honoured Guest & grace the occasion.



Also, in view of the close trade ties between New York and India, it would be also appropriate for the New York Construction and Trenchless Equipment Industry to join the Exhibition and Conference. The event provides a unique annual opportunity for them to meet and personally interact with the crème-de-la-crème of Indian Trenchless Industry and the related Senior officials of the Government.

It will be our pleasure to provide any additional information and my colleagues Mr. Satender Singh Negi (9013125123 / negi@indstt.com) and Mr. Anand Kumar (9873010226 / anand908@gmail.com) will facilitate you for taking this forward.

I shall be grateful if your acceptance could kindly be confirmed.

Yours sincerely,

A handwritten signature in blue ink, appearing to read 'Dr. P R Swarup'.

Dr. P R Swarup,
Chairman
Indian Society for Trenchless Technology